

PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
YUTAKA DODATE	05/17/2017
RECEIVING PARTY DATA	
Name:	A&D COMPANY, LIMITED
Street Address:	3-23-14, HIGASHI-IKEBUKURO, TOSHIMA-KU
City:	TOKYO
State/Country:	JAPAN
Postal Code:	170-0013
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	15709565
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NAME OF SUBMITTER:	THOMAS W. COLE
SIGNATURE:	/Thomas W. Cole/
DATE SIGNED:	09/20/2017
Total Attachments: 1	
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ASSIGNMENT

For good and valuable consideration, the sufficiency and receipt of which is hereby acknowledged, as a below named inventor, I hereby sell and assign to **A&D Company, Limited**

of 3-23-14, Higashi-Ikebukuro, Toshima-ku, Tokyo 170-0013 JAPAN its successors and assigns or other legal representatives all my rights, title and interest, in and for the United States of America, in and to

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invented by me (if only one is named below) or us (if plural inventors are named below) and described in the application for United States Letters Patent therefore as International Application No. **PCT/JP2015/059381** filed on **March 26, 2015** and all United States Letters Patent which may be granted therefore, and all divisions, continuations, reissues, reexaminations and extensions thereof, the said interest being the entire ownership of the said Letters Patent when granted, to be held and enjoyed by said **A&D Company, Limited**, its successors, assigns or other legal representatives, to the full end of the term for which said Letters Patent may be granted, as fully and entirely as the same would have been held and enjoyed by me or us if this assignment and sale had not been made;

And I hereby agree to sign and execute any further documents or instruments which may be necessary, lawful, and proper in the prosecution of the above-named application or in the preparation and prosecution of any continuing, continuation-in-part, substitute, divisional, renewal, reviewed or reissue applications or in any amendment, extension, or interference proceedings, or otherwise to secure the title thereto in said assignee;

And I do hereby authorize and request the Commissioner of Patents to issue said Letters Patent to said **A&D Company, Limited**,

(Full Name)

(Signature)

1. Date: May 17, 2017 Inventor: DODATE Yutaka YUTAKA DODATE
Residence: Same as Post Office Address Citizenship: Japan
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2. Date: May 17, 2017 Inventor: IZUMO Naoto
Residence: Same as Post Office Address Citizenship: Japan
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